Transmitted herewith for filing is the Patent Application of:

mentor: CHII-MING WU, MEI-YUN WANG, CHIH-WEI CHANG, SHAU-LIN SHUE

**METHOD OF FORMING METAL SILICIDE** 

Enclosed are:

X	3 sheets of drawing(s) - formal.				
X	An assignment of the invention to Taiwan Semiconductor Manufacturing Co.				
	An associate power of attorney Applicant claims small entity status				
	Request & Certification under 35 USC 122(b)(2)(b)(i)				

The filing fee has been calculated as shown below:

	(Col. 1)	(Col. 2)	OTHER THAN A SMALL ENTITY	
FOR:	NO. FILED	NO. EXTRA	RATE	FEE
BASIC FEE		><	><	<b>\$</b> 770.
TOTAL CLAIMS	<b>27 -</b> 20=	7	x 18 =	\$ 126.
INDEP CLAIMS	3 -3=	0	x 86 =	\$ 0.
			JB TOTAL	\$ 896.
		AS	SSIGNMENT	\$40.
			OTAL	\$ 936.

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The Commissioner is hereby authorized to charge payment of the following fees associated with this communication or credit any overpayment to Deposit Account No. 19-0033. A duplicate copy of this sheet is enclosed.

Any additional filing fees required under 37 CFR §1.16.

Any patent application processing fees under 37 CFR §1.17.

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## EXPRESS MAIL CERTIFICATE

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I hereby certify that this correspondence is being deposited with the United States Postal Service as Express Mail in an envelope addressed to Assistant Commissioner of Patents, Alexandria, VA, 22313-1450. Applicant and or Attorney requests the date of deposit as the Filing Date.

Signature / Date